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EXPRESS MAIL LABEL NO. EV324207042US
Date of Deposit: September 30, 2003
PATENT
Attorney's Ref. No. P0889D

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Mail Stop PATENT APPLICATION
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P.O. Box 1450
Alexandria, VA 22313-1450

Transmitted herewith for filing is the patent application of:

Inventor(s): Brian Labrec

For: INCREASING THERMAL CONDUCTIVITY OF HOST POLYMER USED WITH LASER
ENGRAVING METHODS AND COMPOSITIONS

Enclosed are:

72 pages of specification, 4 pages of claims, an abstract, Application Data Sheet 2 pages, and a Combined Declaration and Power of Attorney (unsigned).
 13 sheet(s) of drawings.

For	Claims filed	FILING FEE		Rate	Basic Fee
		Number Allotted	Number Extra		
Total Claims	24	20	=	4	\$750.00
Independent Claims	3	3	=	-0-	\$72.00
TOTAL FILING FEE			=		\$822.00

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Date: September 30, 2003

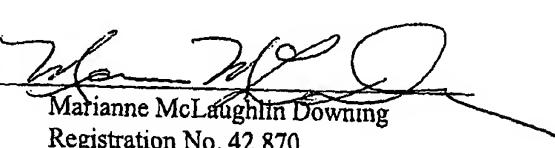
Respectfully submitted,

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By


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